

| DMSMS NOTICE DIMINISHING MANUFACTURING SOURCES AND MATERIAL SHORTAGES | | | | | | | |
|---|-------------------------|--|--|---|-----------------------|--|--|
| 1. TITLE | | | | 2. | DOCUMENT NUMBER | | |
| MICROCIRCUIT, DIGITAL | SF | SPO-2014-D-0008A | | | | | |
| FLOP WITH CLEAR, MON | | - | | DATE (Year, Month, Date) 014 February 14 | | | |
| 4. MANUFACTURER NAME AND AN CAES | | | 5. MANUFACTURER POINT OF CONTACT (NAME) MR. TIM MEADE | | | | |
| 4350 CENTENNIAL BOULE | | 6. MANUFACTURER POINT OF CONTACT TELEPHONE | | | | | |
| COLORADO SPRINGS, COLORADO 80907-3486 | | | (719) 594-8048 | | | | |
| | | | 7. MANUFACTURER POINT OF CONTACT EMAIL | | | | |
| | | | tim.l.meade@cobhamaes.com DATE 10. PRODUCT IDENTIFICATION CODE 11. BASE PART | | | | |
| 8. CAGE CODE 65342 | 9. MANUFACTURER FINAL O | | 10. PRODUCT IDENTIFICATION CODE C273A | | 4ACS273 | | |
| 12. BLANK | | 2011 | 13. SMD NUMBER 96578 | | EVICE TYPE DESIGNATOR | | |
| | | | 15. RHA LEVELS | | ML LEVEL | | |
| | | | NON, R, F, G, AND H | Q A | ND V | | |
| | | | 17. NON QML LEVEL | | LANK | | |
| | | | N/A | | | | |
| HARDENED CMOS TO ON-SEMICONDUCTOR'S 0.6UM C5U COMMERCIAL RADIATION-HARDENED CMOS PROCESS. BECAUSE THE MIGRATED DEVICE IS FORM, FIT, AND FUNCTIONAL TO THE LEGACY DEVICE, IT WILL CONTINUE TO SHIP AS DEVICE TYPE 01. AS PART OF THIS PROCESS MIGRATION, THE RADIATION HARDNESS ASSURANCE LEVEL "H" AND CASE OUTLINE "R" WILL NO LONGER BE AVAILABLE FROM AN APPROVED SOURCE OF SUPPLY. CAES WILL ACCEPT ORDERS FOR RHA LEVEL "H" AND PACKAGE OUTLINE "R" ON A "FIRST COME, FIRST SERVED" BASIS, THROUGH JUNE 2014 OR UNTIL INVENTORY EXHAUSTS. ADDITIONALLY, DIE SALES AGAINST DIE DETAIL "A" WILL NO LONGER BE AVAILABLE. FUTURE DIE SALES MAY BE ISSUED AGAINST DIE DETAIL "B" OF THE AFFECTED SMD. NOTE: THE NEW DIE SUPPLIED AGAINST DIE DETAIL "B" REQUIRE A SUBSTRATE BIAS TO VSS. THE MIGRATED DEVICE OFFERING WILL BE AVAILABLE WITH THE FOLLOWING OPTIONS: SMD #: 5962-96578 DEVICE TYPE: 01 AVAILABLE RHA DESIGNATORS: R (100Krads (Si)), F (300Krads (Si)), G (500Krads (Si)) DEVICE CLASS: Q, V CASE OUTLINE DESIGNATOR: X (20 LEAD FLAT PACK) OR DIE CODE: 9 LEAD FINISH: A, C, X OR DIE DETAIL: B SHIPMENTS OF THE MIGRATED DEVICE ARE EXPECTED TO BEGIN IN JUNE 2014. See Continuation on page 2 | | | | | | | |
| | | | | | | | |
| 20. ADEPT REPRESENTATIVE | | 21. SIGNA | TURE | | 22. DATE | | |
| Timothy L. Meade | | - | Timothy Meade | | 5 March, 2014 | | |

Continuation Page 2

| Obsolete | SMI | D PINs | | | Vendor Similar PINs | | | |
|------------------|-----|--------|----|-------|---------------------|--|--|--|
| 5962 | Н | 96578 | 01 | V 9 A | UT54ACS273- VDIE | | | |
| 5962 | Н | 96578 | 01 | Q 9 A | UT54ACS273- QDIE | | | |
| 5962 | Н | 96578 | 01 | QRA | UT54ACS273- PQAH | | | |
| 5962 | Н | 96578 | 01 | QXA | UT54ACS273- UQAH | | | |
| 5962 | Н | 96578 | 01 | QRC | UT54ACS273- PQCH | | | |
| 5962 | Н | 96578 | 01 | QXC | UT54ACS273- UQCH | | | |
| 5962 | Н | 96578 | 01 | VRA | UT54ACS273- PVAH | | | |
| 5962 | Н | 96578 | 01 | νха | UT54ACS273- UVAH | | | |
| 5962 | Н | 96578 | 01 | VRC | UT54ACS273- PVCH | | | |
| 5962 | Н | 96578 | 01 | VXC | UT54ACS273- UVCH | | | |
| | | | | | | | | |
| Replace SMD PINs | | | | | Vendor Similar PINs | | | |
| 5962 | G | 96578 | 01 | Q 9 B | UT54ACS273- QDIE | | | |
| 5962 | G | 96578 | 01 | QXA | UT54ACS273- UQAG | | | |

| 5962 | G | 96578 | 01 | QXA | UT54ACS273- | UQAG |
|------|---|-------|----|-------|-------------|------|
| 5962 | G | 96578 | 01 | QXC | UT54ACS273- | UQCG |
| 5962 | G | 96578 | 01 | V 9 B | UT54ACS273- | VDIE |
| 5962 | G | 96578 | 01 | νха | UT54ACS273- | UVAG |
| 5962 | G | 96578 | 01 | VXC | UT54ACS273- | UVCG |
| | | | | | | |